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Date: SEP, 27, 2007

Dear Madam / Sir.

We declare that all of EMI suppression parts added on the EUT, FCC ID: UTBHLC-81XW will be put on mass production product.

(A) C810A110.PCB (Main IC circuit board is including LAN)

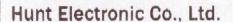
- Respective connecting 22pF capacitance in parallels from No. 1, 3, 4 and 6 pins of LAN port to GND.
- 2. Changing RS14 of circuit board to 33-ohm resistance and connecting a bead in series, which its impedance is 70-ohm.
- 3. Respective connecting 68pF capacitance in parallels to C5, C7 and C8 of circuit board.
- 4. Connecting 33pF capacitance to C10 in parallels.
- 5. Connecting a bead to the RS17 of circuit board in series, which its impedance
- is 80-ohm.
- 6. Adding conductive shielding gasket to LAN port of circuit board to touch the iron case.

WL-3002-1A Mini PCI

1. On the 2.4GHz emission circuit, respective connecting 68pF capacitance in the front and rear of a bead in parallels, which its impedance is 120-ohm.

C810Z110.PCB (The circuit board is up the main circuit board)

- 1. Adding a core on IRIS cable.
- 2. Connecting 120-ohm bead to No.1 pin of CN3 in series.
- Respective connecting 22pF capacitance in parallels from No.2 and 3 pin of CN3 to GND.
- 4. Connecting 0.1uF capacitance in parallels from No. 1 pin of CN1 to GND.
- 5. Adding a core to the wire circuit, which connects SD Card board.





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C810B110.PCB (Board of POWER and Video out)

- 1. Connecting 0.1uF capacitance in parallels from CN3 to GND.
- 2. Connecting 0.1uF capacitance in parallels from No.1 of J4 to GND.
- 3. Connecting 1000pF capacitance in parallels from BNC1 to GND.
- 4. Connecting 1000pF capacitance in parallels from RCA1 to GND.

C810E110.PCB (SD Card Read Board)

- 1. Respective connecting 120-ohm bead in series from No. 3 and 6 pins of J1 to GND.
- 2. Connecting 68pF capacitance to No.5 pin of J1 in parallels.
- 3. Changing CB1 of circuit board to 0.1uF capacitance.
- 4. Changing the L1 to 150-ohm bead.
- (B) Mount one suppression core on adaptor power cord.

Sincerely,

Assistant Vice Resident R&O Dept. Shu-Shing Lin